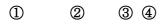
## SCOPE :

This specification applies to the Pb Free high current type SMD inductors for MSCH-2015C-SERIES

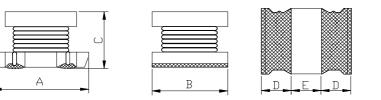
### **PRODUCT INDENTIFICATION**

# <u>MSCH</u> - <u>2015C</u> - <u>100 K</u>



- ① Product Code
- ② Dimensions Code
- ③ Inductance Code
- (4) Tolerance Code

# (1) SHAPES AND DIMENSIONS



A: 2.0±0.3	mm
B: 1.5±0.2	mm
C: 1.7±0.3	mm
D: 0.6Typ.	mm
Е: 0.8Тур.	mm

## (2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

#### TEST INSTRUMENTS

- L : HP 4285A PRECISION LCR METER (or equivalent)
- RDC : CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

## (3) CHARACTERISTICS

(3)-1 Ambient temperature ......  $+60^\circ\!C$  Max.

(3)-2 Operate temperature range ......  $-40^{\circ}$ C  $\sim +125^{\circ}$ C

(Including self temp. rise)

(3)-3 Storage temperature range ......  $-40^\circ\!\!C\!\sim\!+125^\circ\!\!C$ 



# TABLE 1

MAGLAYERS	Inductance	Percent	L Test	Resistance	IDC
PT/NO.	L(µH)	Tolerance	Frequency	RDC(Ω)Max.	(mA) Max.
MSCH-2015C-1R0	1.0	М	1MHz/0.25V	0.26	650
MSCH-2015C-1R5	1.5	М	1MHz/0.25V	0.35	600
MSCH-2015C-2R2	2.2	М	1MHz/0.25V	0.52	500
MSCH-2015C-3R3	3.3	М	1MHz/0.25V	0.65	480
MSCH-2015C-4R7	4.7	М	1MHz/0.25V	0.78	300
MSCH-2015C-5R6	5.6	М	1MHz/0.25V	0.84	280
MSCH-2015C-6R8	6.8	М	1MHz/0.25V	1.30	250
MSCH-2015C-8R6	8.6	М	1MHz/0.25V	1.52	230
MSCH-2015C-100	10	K,M	1MHz/0.25V	1.62	200
MSCH-2015C-150	15	K,M	1MHz/0.25V	2.01	150
MSCH-2015C-220	22	K,M	1MHz/0.25V	3.77	100

※ □ specify the inductance tolerance,K(±10%),M(±20%)

% IDC : Based on inductance change (△L/Lo :  $\leq$  drop 10%) @ ambient temp. 25°C



# (4) RELIABILITY TEST METHOD

## MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board
		in figure 1 and a load applied unitil the figure in the arrow
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)
	no mechanical	PCB dimension shall the page 7/9
	damage or elec-	F(Pressurization)
	trical damege.	Ţ
		R5 45±2 45±2
		PRESSURE ROD figure-1
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board
		and when a vibration having an amplitude of 1.52mm
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.
	damage.	(A total of 6 hours)
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated
oolacrability	More than 90%	over the whole of the sample before hard, the sample shall
		then be preheated for about 2 minutes in a temperature of
		130 $\sim$ 150 $^\circ\!{ m C}$ and after it has been immersed to a depth 0.5mm
		below for 3±0.2 seconds fully in molten solder M705 with
		a temperature of 245±5℃.
		More than 90% of the electrode sections shall be couered
		with new solder smoothly when the sample is taken out of
		the solder bath.



### MECHANICAL

	SPECIFICATION			
There shall be no damage or problems.	SPECIFICATION Temperature profile of reflow soldering (Peak temperature 200:3°C 10 sec			
	no damage or			

#### ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top
resistance	no other	surface and the terminal.
	damage or	The insulation resistance shall be more than $1 \times 10^8 \Omega$ .
	problems.	
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
withstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	∆L/L20℃≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^\circ\!\mathrm{C}$ ,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be $ riangle L/L20^\circ\!$



# **ENVIROMENT CHARACTERISTICS**

TEST ITEM				SPECIFICATION		
High temperature	∆L/Lo≦±5%	The sampl	e sł	hall be left for 96±4 hour	s in an atmospere with	
storage		a temperature of 85±2°C and a normal humidity.				
	There shall be	Upon completion of the measurement shall be made after the				
	no mechanical	sample ha	sample has been left in a normal temperature and normal			
	damage.	humidity fo	humidity for 1 hour.			
Low temperature		The sampl	a sł	all be left for 96+4 bour	s in an atmosphere with	
storage				of -25±3℃.		
	There shall be	-			surement shall be made	
	no mechanical	-	-	ole has been left in a nor		
	damage.			ity for 1 hour.		
Change of	∆L/Lo≦±5%				nuos cycles, such as show	vn
emperature		in the table	e 2 I	below and then it shall b	e subjected to standard	
	There shall be	atmospher	ric c	onditions for 1 hour, aft	er which measurement	
	no other dama-	shall be m	ade			
	ge of problems					
				table 2		
				Temperature	Duration	
			1	<b>−25±3</b> ℃	30 min.	
			-	(Themostat No.1)		
		2	2	Standard	No.4. No.2	
				atmospheric	No.1→No.2	
		3	3	<b>85±2℃</b>	30 min.	
			-	(Themostat No.2)		
			4	Standard	No.2→No.1	
				atmospheric	NO.2-7NO.1	
Moisture storage	∆L/Lo≦±5%	The sampl	e sł	nall be left for 96±4 hour	s in a temperature of	
		<b>40±2°</b> ℃ and	dal	humidity(RH) of 90 $\sim$ 95%	%.	
	There shall be					
	no mechanical					
	damage.					
Fest conditions :			_			
The	sample shall be reflor	w soldered or	nto	the printed circuit board	in every test.	
					· · · · · · ·	

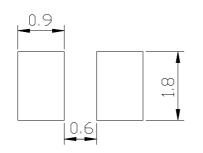


# (5) LAND DIMENSION (Ref.)

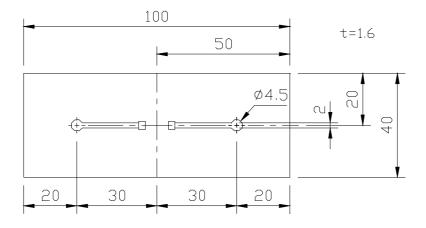
PCB: GLASS EPOXY t=1.6mm

#### (5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) unit : mm

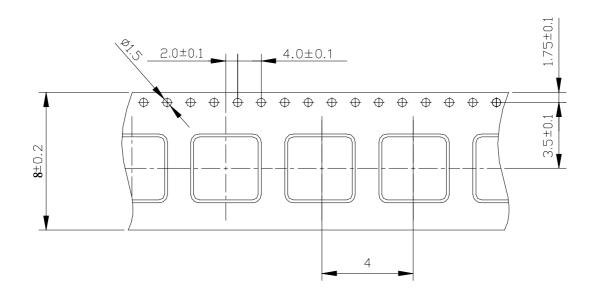


### (5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD

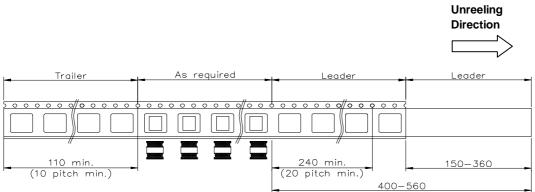




## (6) PACKAGING (6)-1 CARRIER TAPE DIMENSIONS (mm)

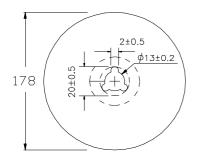


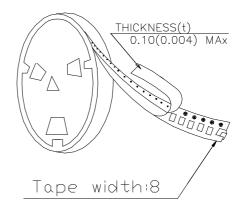
## (6)-2 TAPING DIMENSIONS (mm)





# (6)-3 REEL DIMENSIONS (mm)





### (6)-4 QUANTITY

2500pcs/Reel

The products are packaged so that no damage will be sustained.

